Q

Prod)

Products

EMC

Chip Beads

News

Technical Support

Chip Beads Detailed Information

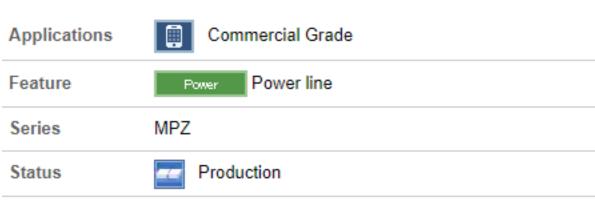
Product Top Page **Technical Support Tools** Search by Part No. Search by Characterstics Cross Reference Catalog Tech Notes FAQ

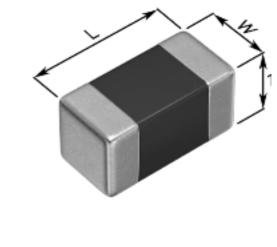
ions in more

Environment

Tech Library

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example products.

Contact Documents Catalog RoHS Certificate SVHC / REACH Certificate Product Lineup Selection Guide Sample Kits Technical Support Tools S-parameter SPICE Netlist (Simple)

SPICE Netlist (Precision)

Equivalent Circuit Model

Electrical Characteristics

Recommended Land Pattern (A)

Recommended Land Pattern (B)

Recommended Land Pattern (C)

Impedance at 100MHz	600Ω ±25%
Rated Current	2A
DC Resistance (Max.)	100mΩ

2.00mm ±0.20mm

1.25mm ±0.20mm

0.85mm ±0.20mm

0.80mm Nom.

1.00mm Nom.

1.20mm Nom.

Other

Size

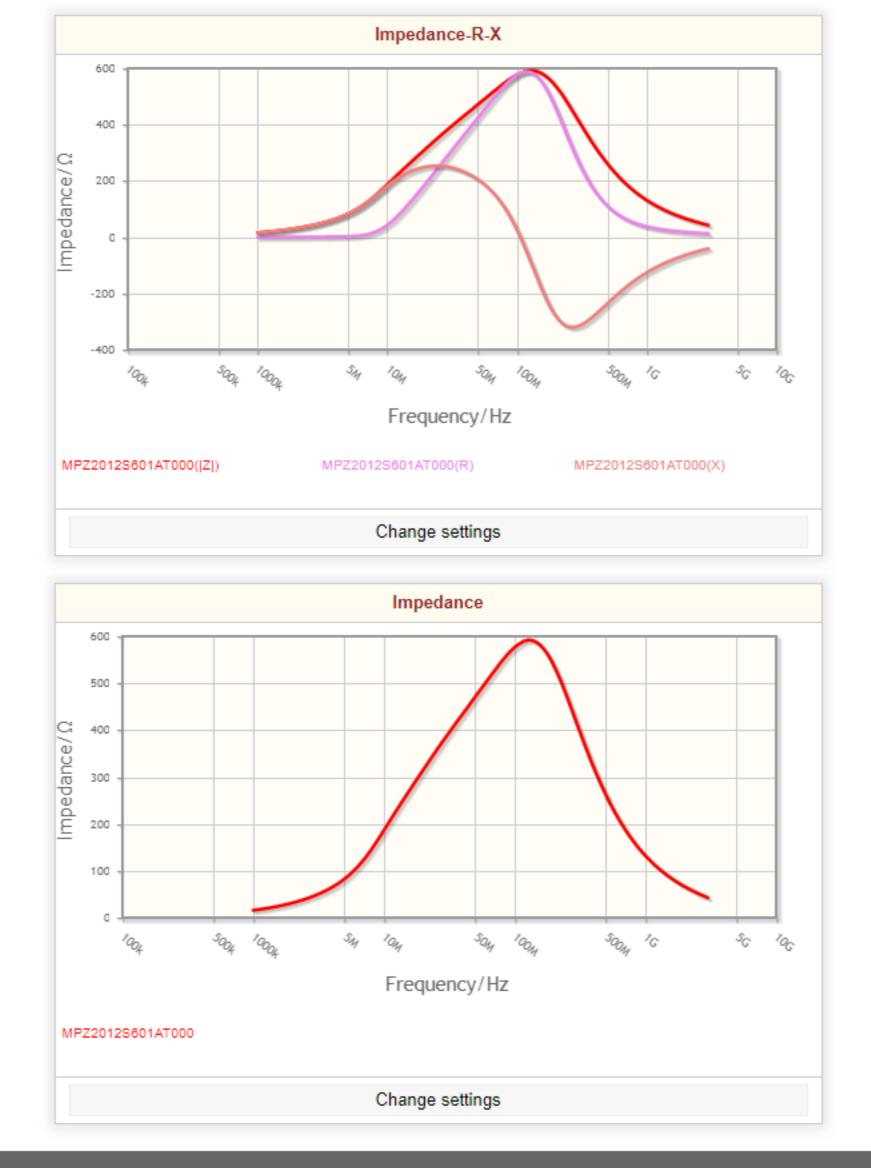
Length(L)

Width(W)

Thickness(T)

Operating Temp. Range (Including Self-Temp. Rise)	-55 to 125°C
Soldering Method	Reflow Iron Soldering
AEC-Q200	NO
Packing	Punched (Paper)Taping [180mm Reel, Tape width 8mm]
Package Quantity	4000pcs
Weight	0.008g

Characteristic Graph (This is reference data, and does not guarantee the products characteristics.)







- > Selection Guides
- > Search by Part No.
- > Search by Characteristics
- Cross Reference
- > Distributor Inventory Check

> Products

- > Capacitors
- > Voltage / Current / Temperature Protection Devices
- > Ceramic Switching / Heating, Piezo Components,
- **Buzzers and Microphones**
- > Ferrites and Accessories
- > Anechoic Chambers and Radio Wave Absorbers
- > Magnets
- > Wireless Power Transfer

> Transparent Conductive Film

- > Solar Cells
- > Lithium-Ion Batteries
- > Application Specific IC (ASIC) Development and Supply

- > Inductors (Coils) > EMC Components
 - > RF Components and Modules > Sensors and Sensor Systems
 - > Transformer

> Noise Suppressing / Magnetic Sheet

- > Power Supplies > Flash Storages
- > FA Systems
- > Micro Modules (Substrates with Built-in ICs, Products Utilizing with SESUB)
- > HDD Heads
- > Solid-State Batteries
- > Biosensors

- > Application Guide
- > Technical Support
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